Docket No. P0298US-7

**PATENT** 

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: MICHAEL S. LEUNG

Serial No. 10/666,399

Group Art Unit: 2814

Filed: September 18, 2003

Title: MOLDED CHIP FABRICATION AND APPARATUS

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

# TRANSMITTAL FOR SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Sir:

Transmitted herewith is a Supplemental Information Disclosure Statement for this application and a PTO Form 1449 citing patent references.

If any additional fee is required, the Commissioner is authorized to charge Deposit Account No. 11-1580. A duplicate of this transmittal is attached.

Respectfully submitted,

Dated: 10/23/08

Jaye G. Heybl/

Registration No. 42,661 Attorney for Applicant

KOPPEL, PATRICK, HEYBL & DAWSON 555 St. Charles Drive, Suite 107 Thousand Oaks, California, 91360

Telephone: (805) 373-0060

### **CERTIFICATE OF MAILING**

I hereby certify that this correspondence is being deposited with the United States Postal Service first Class mail addressed to Commissioner for Patents, P.O. Box 1450, Alexandria, VA, 22313-1450 on:

Date: 1023 08

Marianne Middleton

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OCT 2 7 2008

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Examiner: THAO X. LE

Title: MOLDED CHIP FABRICATION AND APPARATUS

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### SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Sir:

This certification is being made for this Supplemental Information Disclosure Statement. Applicants submit a copy of each of the non-U.S. patent references listed on the attached PTO-1449 (Modified) form for consideration by the Examiner.

I, the person signing below certify that:

Each item of information contained in the supplemental information disclosure statement was cited in a communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of the supplemental information disclosure statement (37 C.F.R. § 1.97(e)(1)).

This submission does not represent that a search has been made or that no better art exists and does not constitute an admission that each or all of the listed documents are material or constitute "prior art". If the Examiner applies any of the documents as prior art against any claim in the application and applicants determine that the cited documents do not constitute "prior art" under United States law, applicants reserve the right to present to the Office the relevant facts and law regarding the appropriate status of such documents.

D-4- J.

Jave G. Heybl

Registration No. 42,661

Attorney for Applicant

Respectfully submitted,

KOPPEL, PATRICK, HEYBL & DAWSON 555 St. Charles Drive, Suite 107 Thousand Oaks, California 91360 (805) 373-0060

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10/33/1

Marianne Middleton